

PNZ303 (PN303)

PIN Photodiode

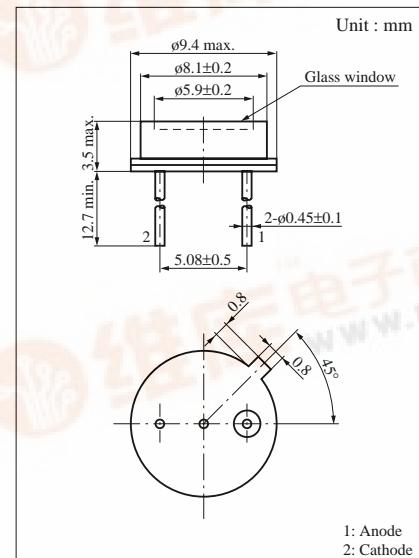
For optical control systems

■ Features

- Fast response which is well suited to high speed modulated light detection : $t_r, t_f = 50$ ns (typ.)
- High photodetection sensitivity and wide dynamic sensitivity
- Peak sensitivity wave length is 900 nm and wide spectral sensitivity
- Wide photodetection area and wide directional angle
- Highly reliable TO-5 standard type package

■ Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Ratings	Unit
Reverse voltage (DC)	V_R	30	V
Power dissipation	P_D	100	mW
Operating ambient temperature	T_{opr}	-30 to +100	°C
Storage temperature	T_{stg}	-40 to +100	°C

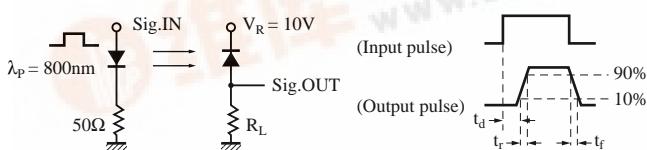


■ Electro-Optical Characteristics ($T_a = 25^\circ\text{C}$)

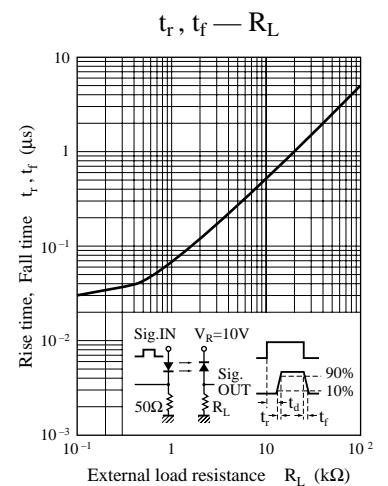
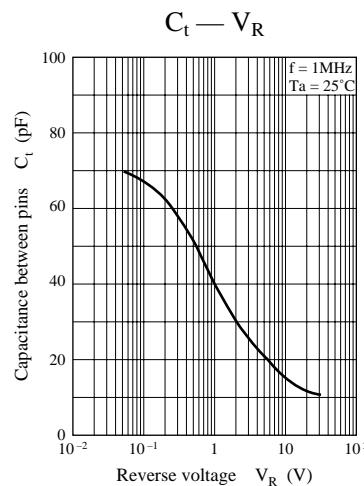
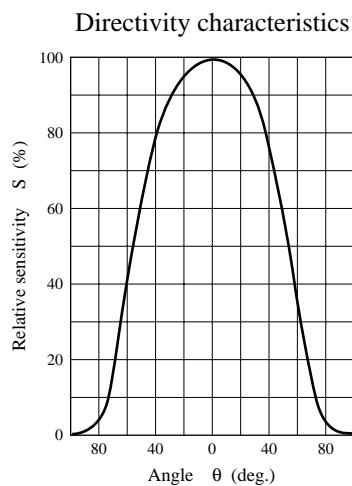
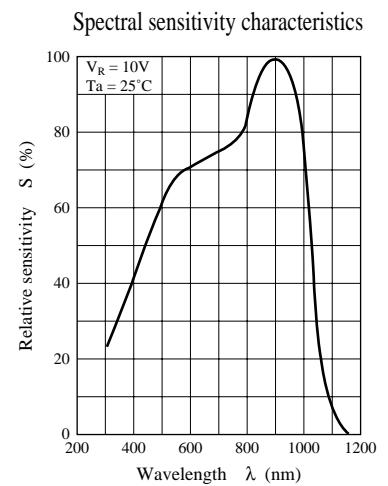
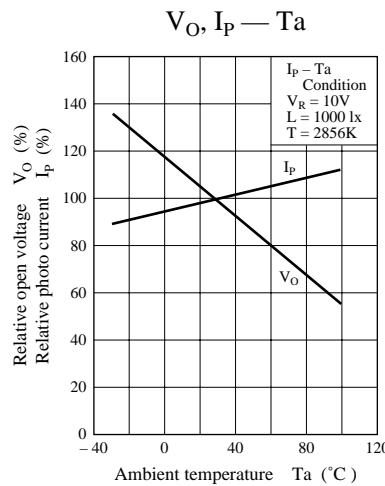
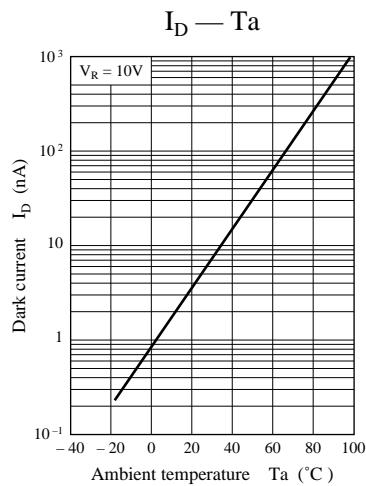
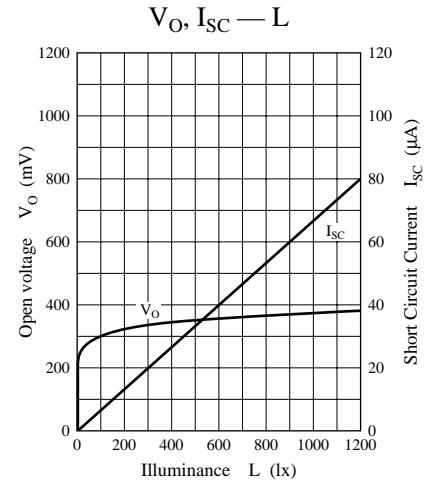
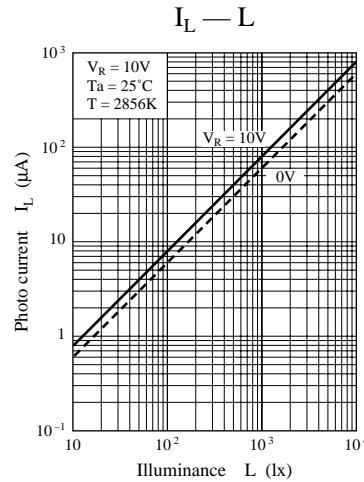
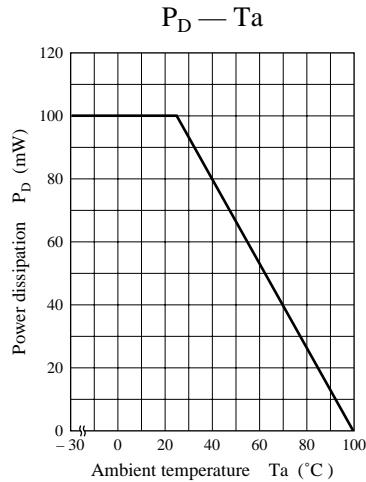
Parameter	Symbol	Conditions	min	typ	max	Unit
Dark current	I_D	$V_R = 10\text{V}$		5	50	nA
Photo current	I_L	$V_R = 10\text{V}, L = 1000 \text{lx}^*1$	50	70		µA
Peak sensitivity wavelength	λ_p	$V_R = 10\text{V}$		900		nm
Response time	t_r, t_f^*2	$V_R = 10\text{V}, R_L = 1\text{k}\Omega$		50		ns
Response time	t_r, t_f^*2	$V_R = 10\text{V}, R_L = 100\text{k}\Omega$		5		µs
Capacitance between pins	C_t	$V_R = 0\text{V}, f = 1\text{MHz}$		70		pF
Acceptance half angle	θ	Measured from the optical axis to the half power point		55		deg.

*1 Measurements were made using a tungsten lamp (color temperature $T = 2856\text{K}$) as a light source.

*2 Switching time measurement circuit



t_d : Delay time
 t_r : Rise time (Time required for the collector photo current to increase from 10% to 90% of its final value)
 t_f : Fall time (Time required for the collector photo current to decrease from 90% to 10% of its initial value)



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